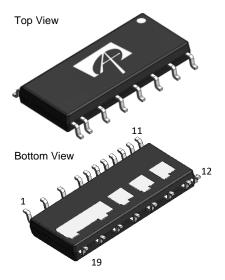


# AIM7E1AR60V1

**Intelligent Power Module** 

## **External View**



Size: 17.9 x 7.5 x 2.5 mm

## **Features**

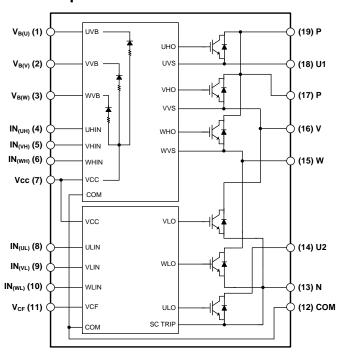
- 600V-1A RC IGBT
- Fully functional 3-phase IGBT-IPM
- Reverse conducting IGBT with monolithic body diode
- · SMD package with exposed-pad
- Wide input interface (3-18V) with Schmitt-trigger input circuit
- Built-in bootstrap diodes with current-limiting resistor
- Control supply under-voltage lockout protection (UVLO)
- Over-temperature (OT) protection
- Short-circuit current protection
- $\bullet$  Controllable fault out signal (VcF) corresponding to SC, UV, OT fault
- Isolation ratings of 1500Vrms/min

## **Applications**

- AC 100~240Vrms low power motor drives
- Fan motors

# Internal Equivalent Circuit

GREEN







# **Ordering Information**

Part Number	Package	Description
AIM7E1AR60V1	IPM-7A	N/A



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit <a href="https://aosmd.com/sites/default/files/media/AOSGreenPolicy.pdf">https://aosmd.com/sites/default/files/media/AOSGreenPolicy.pdf</a> for additional information.

# **Pin Description**

Pin Number	Pin Name	Pin Function
1	$V_{B(U)}$	High-side control supply voltage for U-phase IGBT
2	$V_{B(V)}$	High-side control supply voltage for V-phase IGBT
3	$V_{B(W)}$	High-side control supply voltage for W-phase IGBT
4	IN <sub>(UH)</sub>	Control signal input for high-side U-phase
5	IN <sub>(VH)</sub>	Control signal input for high-side V-phase
6	IN <sub>(WH)</sub>	Control signal input for high-side W-phase
7	Vcc	Control supply voltage
8	IN <sub>(UL)</sub>	Control signal input for low-side U-phase
9	IN <sub>(VL)</sub>	Control signal input for low-side V-phase
10	IN <sub>(WL)</sub>	Control signal input for low-side W-phase
11	Vcf	Controllable fault signal output
12	COM	Common ground for control circuit
13	N	Common Emitter for U/V/W-phase IGBTs connecting to short-circuit current protection input, which can sense short-circuit current through connecting a sensing resistor.
14	U2	U-phase output 2. This pin should be connected to U1(pin 18)
15	W	W-phase output
16	V	V-phase output
17	Р	DC-link bus positive input
18	U1	U-phase output 1. This pin should be connected to U2(pin 14)
19	Р	DC-link Bus positive input

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# Absolute Maximum Ratings (TJ=25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Units			
Inverter							
BV <sub>CES</sub>	IGBT Breakdown Voltage	T <sub>J</sub> =25°C	600	V			
I.	IGBT Collector Current (Continuous)	T <sub>C</sub> =25°C	1	Α			
Ic	IGBT Collector Current (Continuous)	T <sub>C</sub> =80°C	0.5	Α			
I <sub>CP</sub>	IGBT Collector Current (Pulsed)	T <sub>C</sub> =25°C, <100µs pulse width	1.5	Α			
P <sub>D</sub>	Maximum Power Dissipation	per IGBT T <sub>C</sub> =25°C	33.4	W			
TJ	Operating Junction Temperature		-40 to 150	°C			
Control (F	Protection)						
Vcc	Control Supply Voltage	Vcc-COM	-0.3 ~ 20	V			
V <sub>BS</sub>	High-side Control Supply Voltage	$V_{B(U)}$ -U, $V_{B(V)}$ -V, $V_{B(W)}$ -W	-0.3 ~ 20	V			
VIN	Control Signal Input Voltage	IN(UH), IN(VH), IN(WH), IN(UL), IN(VL), IN(WL)-COM	-0.3 ~ Vcc+0.5	V			
Vcf	Fault Output Voltage	V <sub>CF</sub> -COM	-0.3 ~ 5.5	V			
Thermal Resistance							
R <sub>th(j-c)Q</sub>	Investigation to Cook They would Desigte a	Single RC-IGBT	3.0	°C/W			
R <sub>th(j-c)</sub> F	Junction to Case Thermal Resistance	Single Diode	4.3	°C/W			
Module							
Tc	Module Case Operation Temperature		-30 to 125	°C			
T <sub>STG</sub>	Storage Temperature		-40 to 150	°C			
Viso	Isolation Voltage	60Hz, sinusoidal, AC 1min, between connected all pins and package top-center	1500	V <sub>rms</sub>			

# **Recommended Operation Conditions**

Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
$V_{PN}$	Bus Supply Voltage	$V_P-V_N$	0	300	450	V
Vcc	Control Supply Voltage	Vcc-COM	13.5	15.0	16.5	V
$V_{BS}$	High-side Control Supply Voltage	$V_{B(U)}$ -U, $V_{B(V)}$ -V, $V_{B(W)}$ -W	13.5	15.0	16.5	V
dV <sub>CC</sub> /dt, dV <sub>BS</sub> /dt	Control Supply Voltage Variation		-1	-	1	V/µs
t <sub>dead</sub>	Dead time	Control signals between high-side and low-side	1.5	-	-	μs
f <sub>PWM</sub>	PWM Input Frequency		-	16	-	kHz
PW <sub>IN(ON)</sub>	Minimum Input Pulse Width	(Note 1)	0.7	-	-	μs
PW <sub>IN(OFF)</sub>	Millimum input Puise Width	(Note 1)	0.7	-	-	μs

#### Note:

1. IPM may not respond if the input pulse width is less than  $PW_{IN(ON)}$ ,  $PW_{IN(OFF)}$ .

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# Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise specified)

Symbol	Parameter	Condition	Min.	Тур.	Max	Units		
Inverter								
V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	V <sub>CC</sub> =V <sub>BS</sub> =15V, V <sub>IN</sub> =5V	I <sub>C</sub> =1A	-	2.0	2.6	V	
VF	Emitter-Collector Forward Voltage	Vcc=V <sub>BS</sub> =15V, V <sub>IN</sub> =0	Ic=1A	-	2.4	2.9	٧	
t <sub>OFF</sub>	-			•	1000	-	ns	
t <sub>f</sub>		V <sub>PN</sub> =300V, V <sub>CC</sub> =V <sub>BS</sub> =15	V		90	-	ns	
ton	Switching Times	$I_C=1A$ , $V_{IN}=0V \leftrightarrow 5V$			600	-	ns	
t <sub>r</sub>		Inductive load (high-side	e)	-	50	-	ns	
t <sub>rr</sub>				•	210	-	ns	
ICES	Collector-Emitter Leakage Current	V <sub>IN</sub> =0V, V <sub>CE</sub> =600V		-	-	1	mA	
Control (Pr	otection)							
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> Supply Current	V <sub>CC</sub> =15V, IN <sub>(UL, VL, WL)</sub> =0V	V <sub>CC</sub> -COM	-	-	1.5	mA	
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current	V <sub>BS</sub> =15V, IN <sub>(UH, VH, WH)</sub> =0V	$V_{BS}=15V$ , $V_{B(U)}-U$ , $V_{B(V)}-V$ ,		-	0.3	mA	
UVcct		Trip Level	-(,	10.3	11.4	12.5	V	
UVccr	Supply Circuit Under-voltage	Reset Level		10.8	11.9	13.0	V	
UV <sub>BST</sub>	Protection	Trip Level		9.0	10.0	11.0	V	
UV <sub>BSR</sub>	]	Reset Level		10.0	11.0	12.0	V	
I <sub>IN</sub>	Input Bias Current	V <sub>IN</sub> =5V		1	650	850	μΑ	
V <sub>IN,TH(ON)</sub>	ON Threshold Voltage	IN(UH), IN(VH), IN(WH), IN(UL), IN(VL), IN(WL) — COM		-	-	2.5	V	
V <sub>IN,TH</sub> (OFF)	OFF Threshold Voltage			0.8	-	-	V	
Vsc	Short-circuit Trip Level	Vcc=15V		0.9	1	1.1	V	
OTT	Over-temperature Protection	Vcc=15V Trip Lev		110	130	150	°C	
OTHYS	Over-temperature i rotection	Hystere	sis of Trip Reset	-	30	-	°C	
Vcfh	Fault Output Voltage	V <sub>N</sub> =0V		4.9	-	-	V	
Vcfl		V <sub>N</sub> =1V	V <sub>N</sub> =1V		-	0.5	V	
V <sub>CF+</sub>	V <sub>CF</sub> positive going threshold			-	1.9	2.2	V	
V <sub>CF</sub> -	V <sub>CF</sub> negative going threshold			8.0	1.1	-	V	
t <sub>FO</sub>	Fault Output Pulse Width (Note 2)	When C <sub>CF</sub> is not conne	20	-	-	μs		
Bootstrap	Bootstrap Diode							
V <sub>F(BSD)</sub>	Bootstrap Diode Forward Voltage	I <sub>F</sub> =10mA including voltage drop by limiting resistor		-	3.6	-	V	
R <sub>BSD</sub>	Bootstrap Diode Equivalent Resistance			-	360	-	Ω	

#### Note:

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Fault output signal V<sub>CF</sub> becomes low when one of protections OT, SC or UVLO is triggered. When failures happen like UV or OT, V<sub>CF</sub> keeps low continuously until recovering from UV or OT state. 20μs indicates min. fault output duration time without pull-down capacitor. It can be controlled by the capacitor value as shown in Figure 1.



## **Functional Description**

#### **Controllable Fault Output Circuit**

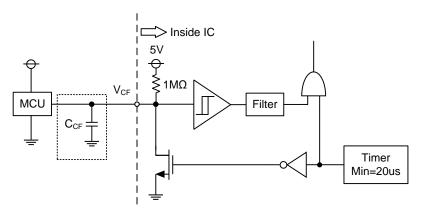


Figure 1. V<sub>CF</sub> Output Circuit

 $V_{\text{CF}}$  pin provides an enable functionality that enables to shut down all low side IGBTs, besides it can be controlled with external MCU. When  $V_{\text{CF}}$  is in the high state, the IPM is able to operate normally. Meanwhile,  $V_{\text{CF}}$  is in a low state, the low-side IGBTs are turned off until  $V_{\text{CF}}$  recovers to the high state. In addition, the  $V_{\text{CF}}$  pin provides fixed or adjustable pulse width of fault output signal using external capacitor. If  $V_{\text{CF}}$  pin is left, the fault output pulse width  $t_{\text{FO}}$  is maintained as the low state for minimum 20us. If a capacitor is connected, the pulse width can be increased depending on to the capacitance.

The pulse width can be determined by the following formula;

$$t_{FO} = -(1M\Omega \cdot C_{CF}) \cdot ln\left(1 - \frac{V_{CF+}}{5V}\right) + 20usec$$

$$\approx 478k \cdot C_{CF} + 20usec$$

for example, adding C<sub>CF</sub>=1nF, t<sub>FO</sub>≈500us.

#### Short-Circuit (SC) Protection and Time Chart

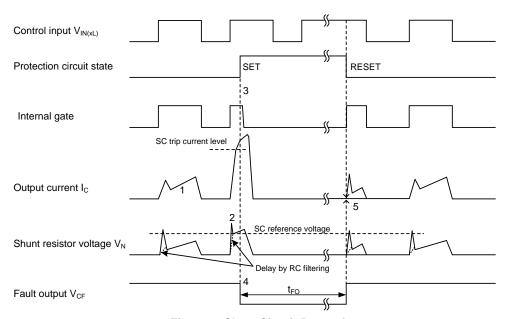


Figure 2. Short-Circuit Protection

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Adding shunt resistors between terminal N (Pin 13) and COM (Pin 12), SC protection can be operable. SC protection operational time chart can be described in Figure 2.

- (1) In normal operation, IGBT turns on and normal collector current Ic happens.
- (2) Once over current touches to SC trip level, SC protection is triggered.
- (3) All low-side IGBTs' gate are turned off. Accordingly, all low-side IGBTs are turned off.
- (4) Fault signal V<sub>CF</sub> becomes from high to low and sustains low for t<sub>FO</sub> (minimum 20µs).
- (5) V<sub>CF</sub> recovers to high, normal operation restarts according to the input control signal.

## V<sub>CC</sub> Under-voltage Lock-out (UVLO) Protection and Time Chart

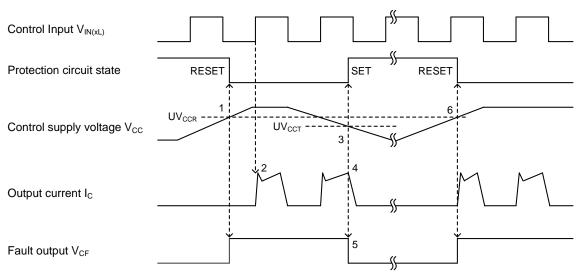


Figure 3. Under-Voltage Protection (Low-side, Vcc)

- (1) Supply voltage  $V_{CC}$  becomes higher than under-voltage reset level (UV<sub>CCR</sub>), and IGBTs are turned on by the next ON signal.
- (2) Normal operation: IGBTs turn-on and output current.
- (3) V<sub>CC</sub> level drops to under-voltage trip level (UV<sub>CCT</sub>).
- (4) All low-side IGBTs are turned off regardless of control input condition.
- (5)  $V_{\text{CF}}$  output becomes low and stays as long as  $V_{\text{CC}}$  is below  $UV_{\text{CCR}}$ .
- (6) Once Vcc level reaches UVccR, IGBTs restart working normally according to the input control signal.

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## V<sub>BS</sub> Under-voltage Lock-out (UVLO) Protection and Time Chart

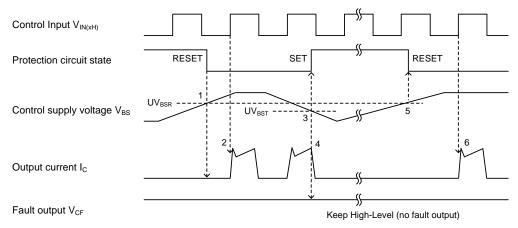


Figure 4. Under-Voltage Protection (High-side, VBS)

- (1) Control supply voltage V<sub>BS</sub> rises. After the voltage reaches under-voltage reset level (UV<sub>BSR</sub>), IGBTs are turned on by the next ON signal.
- (2) Normal operation: IGBTs turn on and output current.
- (3) V<sub>BS</sub> level drops to under-voltage trip level (UV<sub>BST</sub>).
- (4) All high-side IGBTs are turned off regardless of control input condition.
- (5) V<sub>BS</sub> level reaches UV<sub>BSR</sub>.
- (6) Normal operation starts according to the input control signal.

## Over Temperature (OT) Protection and Time Chart

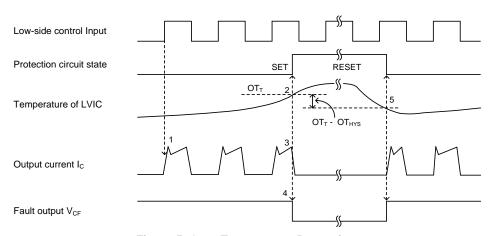


Figure 5. Over-Temperature Protection

- (1) Normal operation: IGBTs turn on and output current.
- (2) LVIC temperature exceeds over-temperature trip level (OT<sub>T</sub>).
- (3) All low-side IGBTs are turned off regardless of control input condition.
- (4) V<sub>CF</sub> output becomes low and stays as long as LVIC temperature is over OT<sub>T</sub>.
- (5) LVIC temperature drops to over-temperature reset level (OT<sub>T-OTHYS</sub>). Normal operation starts according to the input control signal.

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# **Switching Time Definition**

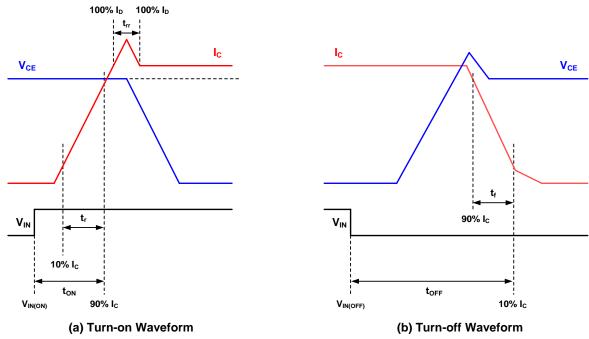


Figure 6. Switching Times Definition

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# **Typical Application Circuit and Design Guide**

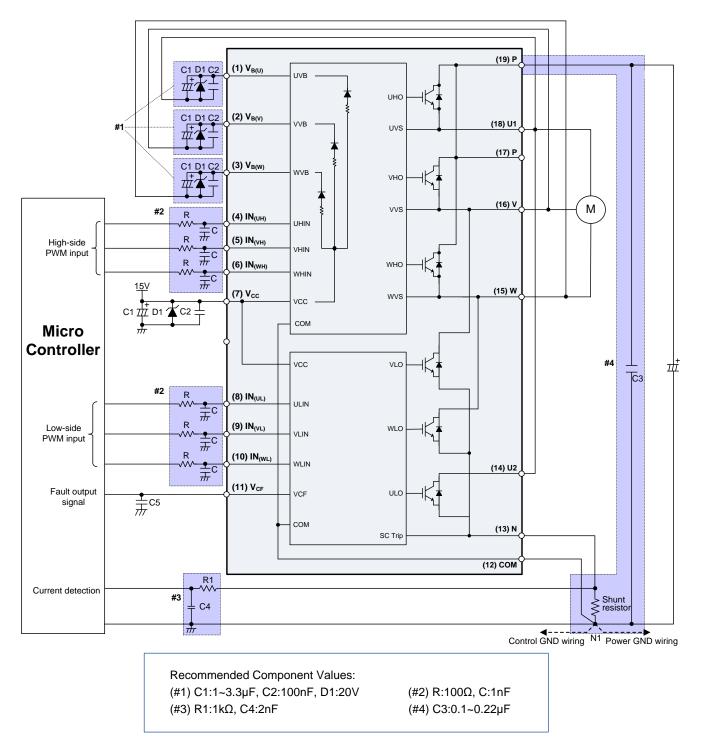


Figure 7. Typical Application Circuit

## #1: Filter circuits for Vcc and VBS

It is recommended that all capacitors are placed as close to the IPM as possible. C1 is recommended to electrolytic type with good temperature and frequency characteristics. C2 should be ceramic type with  $0.1-2\mu F$ , good temperature, frequency and DC bias characteristics. A zener diode D1 (20V/1W) is recommended between each pair of control supply pins to avoid damage by external surge.

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#### #2: Filter circuits for IN terminal

IN pins work with active-high and there is a minimum  $3.5k\Omega$  pull-down resistor IPM inside. To prevent malfunction, the layout of each IN pins from MCU should be as short as possible. Recommended RC filter is 100ns of time constant, which can be adjusted considering amount of noise.

#### #3: Filter circuits for SC and VCF

Selection of the R1\*C4 filter components for short-circuit protection is recommended to have tight tolerance and temperature-compensated type. The R1\*C4 time constant should be set such that SC current is shut down within 2µs; (typically 1.5-2µs). R1 and C4 should be placed as close to N pin as possible. SC interrupting time may vary with layout patterns and components selections, therefore thorough evaluation in the system is necessary.

Capacitor C5 can adjust fault output pulse duration time V<sub>CF</sub>. Without C5, V<sub>CF</sub> has fixed minimum 20us pulse width. For the design guide, please refer to the Figure 1.

#### #4: Shunt resistance, GND layout and snubber capacitor

For designing a shunt resistor, it is recommended that short circuit trip level should be set less than 1.6 times of the rated current and the shunt resistor should be selected non-inductive and high accurate characteristic.

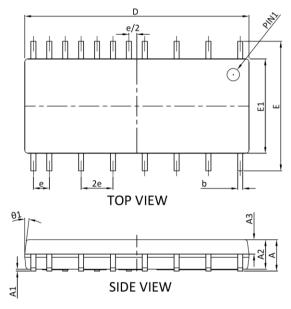
It is recommended to connect the control GND and power GND at a single point (N1) near the terminal of the shunt resistor. Control-related components such as V<sub>CC</sub>, IN and V<sub>CF</sub> should be connected to control GND and power-related components of C3 and dc-link capacitor should be connected to power GND to avoid noise interference from power GND to control GND.

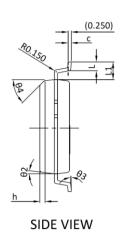
The snubber capacitor C3 plays a role of absorbing high spike voltage on dc-link during switching operation so that it should be placed as close to pin P and pin N as possible. Generally a 0.1-0.22µF snubber capacitor is recommended.

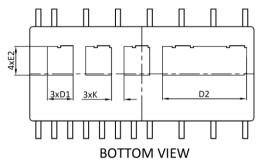
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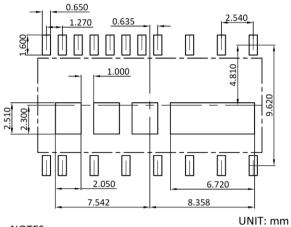
# Package Dimensions, IPM-7A







## LAND PATTERN RECOMMENDATIONS



	DIMENSION IN MILLIMETRES			DIMENSION IN INCHS			
SYMBOLS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	2.304	2.504	2.704	0.091	0.099	0.106	
A1	0.050	0.150	0.250	0.002	0.006	0.010	
A2	2.254	2.354	2.454	0.089	0.093	0.097	
А3	1.050	1.150	1.250	0.041	0.045	0.049	
D	17.800	17.900	18.000	0.701	0.705	0.709	
D1	1.960	2.060	2.160	0.077	0.081	0.085	
D2	6.620	6.720	6.820	0.261 0.265 0.26			
Ε	10.140	10.340	10.540	0 0.399 0.407 0.4			
E1	7.420	7.520	7.620	0.292	0.296 0.30		
E2	2.200	2.300	2.400	0.087	0.091	0.094	
L	0.505	0.705	0.905	0.020	0.028	0.036	
L1	1.210	1.410	1.610	0.048	0.056	0.063	
K	1.000	-	-	0.039	-	-	
е		1.270TYP		0.050TYP.			
b	(	0.410TYP		0.016TYP.			
С	0.254TYP.			0.010TYP.			
θ1	7°TYP.			7°TYP.			
θ2	7°TYP.			7°TYP.			
θ3	0°		8°	0°		8°	
θ4		45°TYP.			45°TYP.		
h		0.381TYP. 0.015TYP.					

#### **NOTES**

- 1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS, MOLD FLASH SHOULD BE LESS THAN 6 MIL.
- 2. TOLERANCE 0.100 MILLIMETERS UNLESS OTHERWISE SPECIFIED.
- 3. CONTROLLING DIMENSION IS MILLIMETER, CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

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